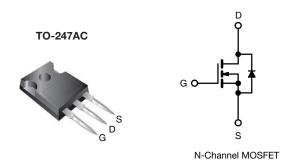
SiHG085N60EF

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Vishay Siliconix

EF Series Power MOSFET With Fast Body Diode



PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	650					
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.073				
Q _g max. (nC)	63					
Q _{gs} (nC)	17					
Q _{gd} (nC)	9					
Configuration	Single					

FEATURES

- 4th generation E series technology
- Low figure of merit (FOM) Ron x Qg
- Low effective capacitance (Co(er))
- · Reduced switching and conduction losses
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
- Welding
- Induction heating
- Motor drives
- Battery chargers
- Solar (PV inverters)

ORDERING INFORMATION				
Package	TO-247AC			
Lead (Pb)-free and halogen-free	SiHG085N60EF-T1GE3			

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \text{ °C}$, unless otherwise noted)								
PARAMETER			SYMBOL	LIMIT	UNIT			
Drain-source voltage			V _{DS}	600	V			
Gate-source voltage			V _{GS}	± 30	V			
Continuous drain current (T _J = 150 °C)	V at 10 V	T _C = 25 °C	- I _D -	34				
	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C		21	А			
Pulsed drain current ^a			I _{DM}	75				
Linear derating factor				1.82	W/°C			
Single pulse avalanche energy b			E _{AS}	173	mJ			
Maximum power dissipation			PD	184	W			
Operating junction and storage temperature ra	nge		T _J , T _{stg}	-55 to +150	°C			
Drain-source voltage slope $T_J = 125 \text{ °C}$			dv/dt	100	V/ns			
Reverse diode dv/dt d		uv/dl	50	v/ns				

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 120 V, starting T_J = 25 °C, L = 28.2 mH, R_q = 25 Ω , I_{AS} = 3.5 A

c. 1.6 mm from case

d. $I_{SD} \leq I_D$, di/dt = 100 A/µs, starting T_J = 25 °C





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THERMAL RESISTANCE RAT	INGS								
PARAMETER	SYMBOL	TYP. MAX.			UNIT				
Maximum junction-to-ambient	R _{thJA}	- 40			9 0 AM				
Maximum junction-to-case (drain)	R _{thJC}	- 0.55				°C/W			
SPECIFICATIONS (T _J = 25 $^{\circ}$ C, u	unless otherwi	se noted)							
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static									
Drain-source breakdown voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 2	250 μA	600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C,	$I_D = 1 \text{ mA}$	-	0.56	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 µA	3.0	-	5.0	V	
Gate-source leakage	1	$V_{GS} = \pm 20 V$			-	-	± 100	nA	
	I _{GSS}	$V_{GS} = \pm 30 \text{ V}$			-	-	± 1	μA	
7	I	$V_{DS} = 480 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			-	-	1	μA	
Zero gate voltage drain current	IDSS	V _{DS} = 480 V	, $V_{GS} = 0 V$	′, T _J = 125 °C	-	-	2	mA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	ار	₀ = 17 A	-	0.073	0.084	Ω	
Forward transconductance ^a	9 _{fs}	V _{DS} :	= 10 V, I _D =	= 17 A	-	16	-	S	
Dynamic	-	•				•	•	•	
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 100 KHz		-	2733	-	pF		
Output capacitance	C _{oss}			-	100	-			
Reverse transfer capacitance	C _{rss}			-	3	-			
Effective output capacitance, energy related ^a	C _{o(er)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	107	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	645	-			
Total gate charge	Qg				-	42	63		
Gate-source charge	Q _{gs}	V _{GS} = 10 V I _D = 17 A, V _{DS} = 480 V		A, V _{DS} = 480 V	-	17	-	nC	
Gate-drain charge	Q _{gd}				-	9	-		
Turn-on delay time	t _{d(on)}				-	32	64		
Rise time	t _r	V_{DD} = 480 V, I_D = 17 A, V_{GS} = 10 V, R_g = 9.1 Ω		-	75	113	ns		
Turn-off delay time	t _{d(off)}			-	48	96			
Fall time	t _f			-	53	80			
Gate input resistance	R _g	f = 1 MHz, open drain		0.3	0.7	1.4	Ω		
Drain-Source Body Diode Characteristi	ics								
Continuous source-drain diode current	١ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	30	A		
Pulsed diode forward current	I _{SM}			-	-	75			
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 17 A, V _{GS} = 0 V		-	-	1.2	V		
Reverse recovery time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 17 \text{ A},$ di/dt = 100 A/µs, V _B = 400 V		-	109	218	ns		
				H	1		-		
Reverse recovery charge	Q _{rr}	- 2 ا ما:/ما+	$0, 1_F = 1_S$	400.1/	-	0.6	1.2	μC	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 V to 400 V

b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 V to 400 V



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

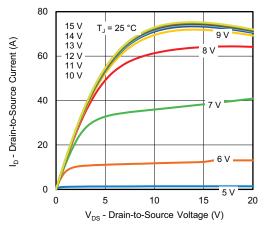


Fig. 1 - Typical Output Characteristics

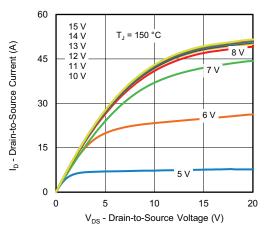


Fig. 2 - Typical Output Characteristics

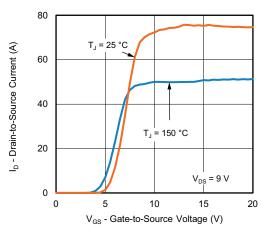


Fig. 3 - Typical Transfer Characteristics

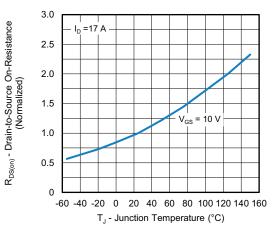


Fig. 4 - Normalized On-Resistance vs. Temperature

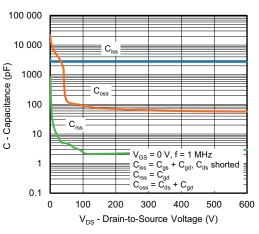
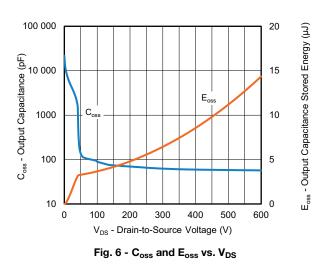


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



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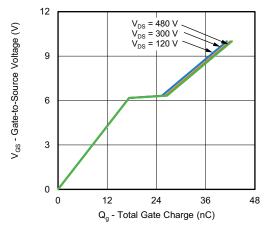


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

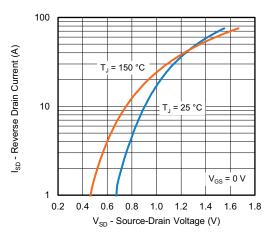


Fig. 8 - Typical Source-Drain Diode Forward Voltage

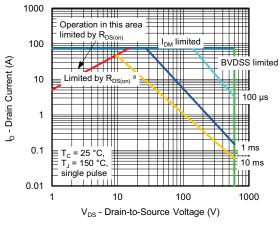


Fig. 9 - Maximum Safe Operating Area

Note

a. V_{GS} > minimum V_{GS} at which $R_{DS(on)}$ is specified

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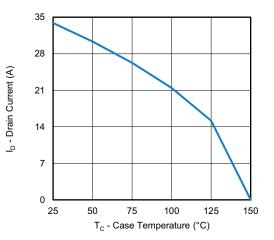


Fig. 10 - Maximum Drain Current vs. Case Temperature

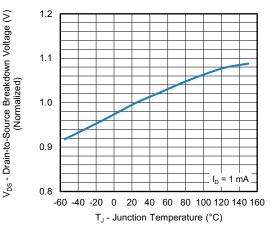
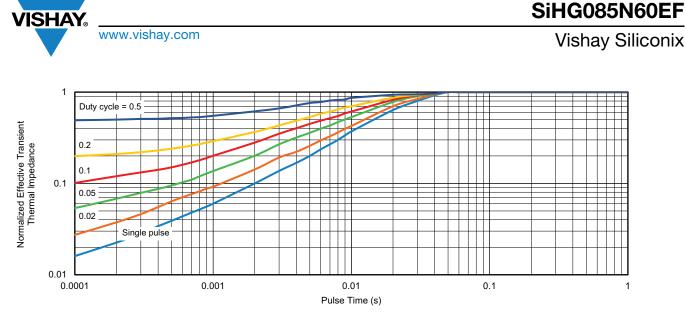
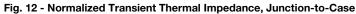


Fig. 11 - Temperature vs. Drain-to-Source Voltage





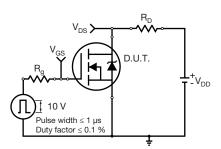


Fig. 13 - Switching Time Test Circuit

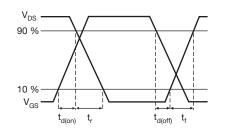


Fig. 14 - Switching Time Waveforms

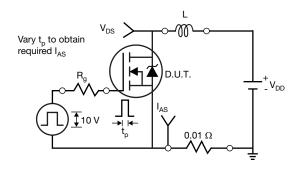


Fig. 15 - Unclamped Inductive Test Circuit

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V_{DD} $\rm V_{\rm DS}$ I_{AS}

Fig. 16 - Unclamped Inductive Waveforms

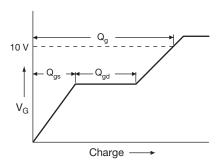
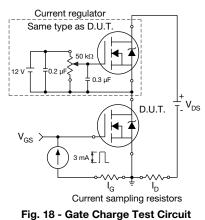


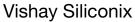
Fig. 17 - Basic Gate Charge Waveform



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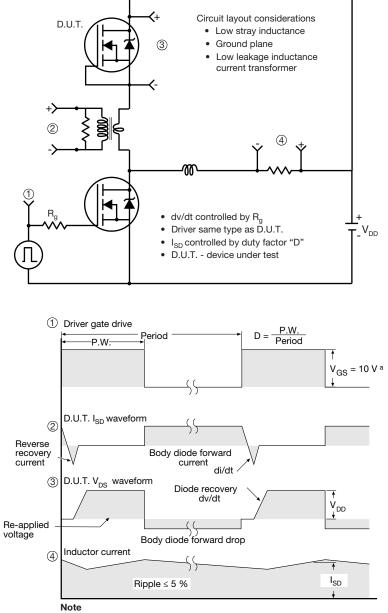
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Peak Diode Recovery dv/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

Fig. 19 - For N-Channel

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